

SPECIFICATIONS:

- G: 

2RJ1733-000X11F

— *PACKAGE*

—HOUSING COLOR

—CONTACT


—CONTACT AREA PLATING

- 1: GOLD FLASH ON CONTACT AREA,
MATTE TIN PLATED ON SOLDER AREA.
NICKEL UNDERPLATED OVERALL.
- 2: 30u "GOLD ON CONTACT AREA,
MATTE TIN PLATED ON SOLDER AREA.
NICKEL UNDERPLATED OVERALL.

UNLESS OTHERWISE SPECIFIED TOLERANCES	 Singatron Enterprise Co., Ltd. 信音企業股份有限公司
--	--



Singatron Enterprise Co., Ltd.
信音企業股份有限公司



TITLE	RJ45 JACK, W/SHIELD, R/A, DIP TYPE, H=4.0mm				
DWN	Even 2019.04.02	PART NO. 2RJ1733-000X11F			
CHKD		SCALE 3/1	UNIT: mm		
APVD	MPCL 2019.04.02	SIZE: A3	SHEET: 1 OF 1	REV: D	

CUSTOMER COPY



pin define:

10/100Base-T		100Base-T4	
Pin 1	TX+	Pin 1	TX_D1+
Pin 2	TX-	Pin 2	TX_D1-
Pin 3	RX+	Pin 3	RX_D2+
Pin 4	n/c	Pin 4	BI_D3+
Pin 5	n/c	Pin 5	BI_D3-
Pin 6	RX-	Pin 6	RX_D2-
Pin 7	n/c	Pin 7	BI_D4+
Pin 8	n/c	Pin 8	BI_D4-

LED ELECTRICAL CHARACTERISTIC					
NODE		COLOR	———	WAVELENGTH	FORWARD CURRENT
A1(+)	A2(-)	GREEN	A1  A2	564~577nm	If=20mA
B1(+)	B2(-)	AMBER	B1  B2	584~594nm	If=20mA